

# Status of the Mu3e Tile detector

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for the Mu3e collaboration



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Kirchhoff Institut für Physik, Universität Heidelberg

- Mu3e Experiment
- Mu3e Tile detector
  - Overview
  - Production
  - QA measurements
- Integration into the experiment
- Conclusions & Outlook

# The Mu3e experiment



- Search for Charged Lepton Flavour Violation

- $\mu^+ \rightarrow e^+ e^+ e^-$  ( $\mu \rightarrow 3e$ )

- Highly suppressed in SM (with neutrino mixing):

- $\text{Br}_{\mu \rightarrow 3e} \approx 10^{-54}$

- Probe for physics beyond SM

- Current limit (SINDRUM, 1988)

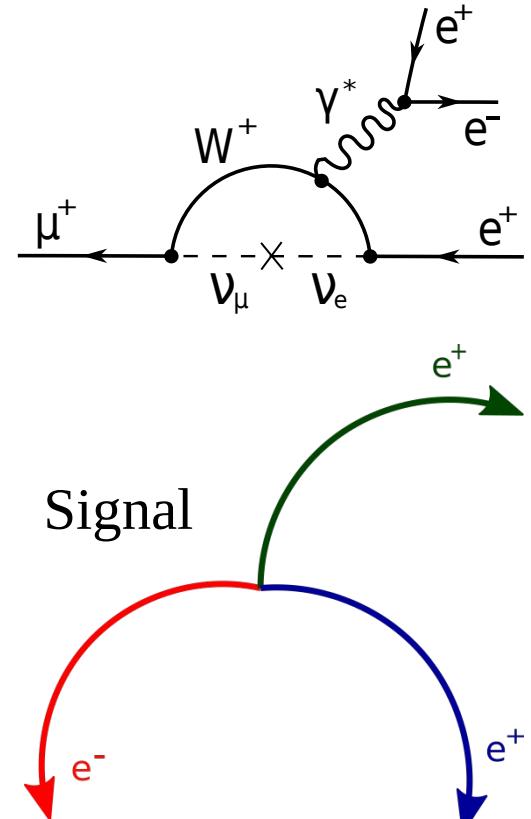
- $\text{Br}_{\mu \rightarrow 3e} < 10^{-12}$

- Goal for Mu3e experiment

- $\text{Br}_{\mu \rightarrow 3e} < 10^{-16}$  (Phase 1:  $\text{Br}_{\mu \rightarrow 3e} < 2 \times 10^{-15}$ )

- Stopping target experiment at PSI (Switzerland)

- High-intensity muon beam ( $1 \times 10^8 \text{ Hz}$ )

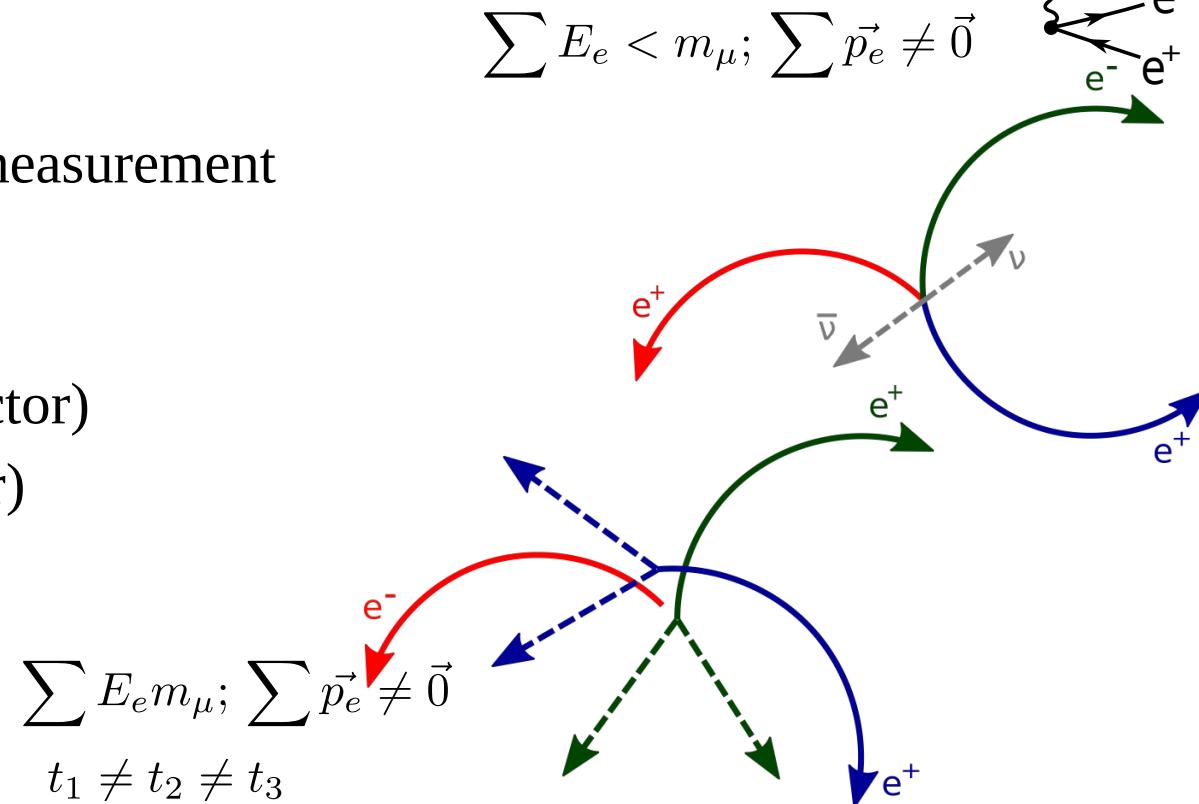


$$\sum E_e = m_\mu; \sum \vec{p}_e = \vec{0}$$

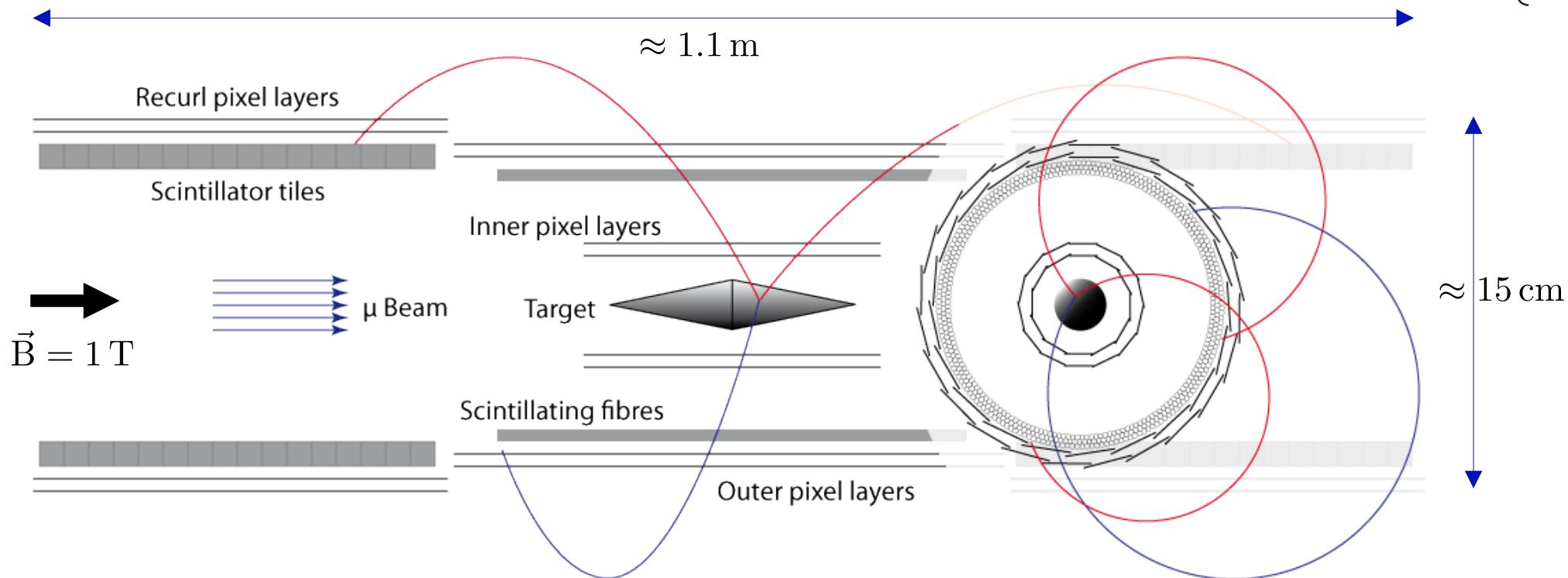
# The Mu3e experiment



- Background contributions need to be reduced
  - Internal conversion
  - Combinatorial background
- Precise momentum and vertex measurement
  - Pixel tracker
- Precise timing measurement
  - Scintillating Fibre (Fibre detector)
  - Scintillating Tile (Tile detector)

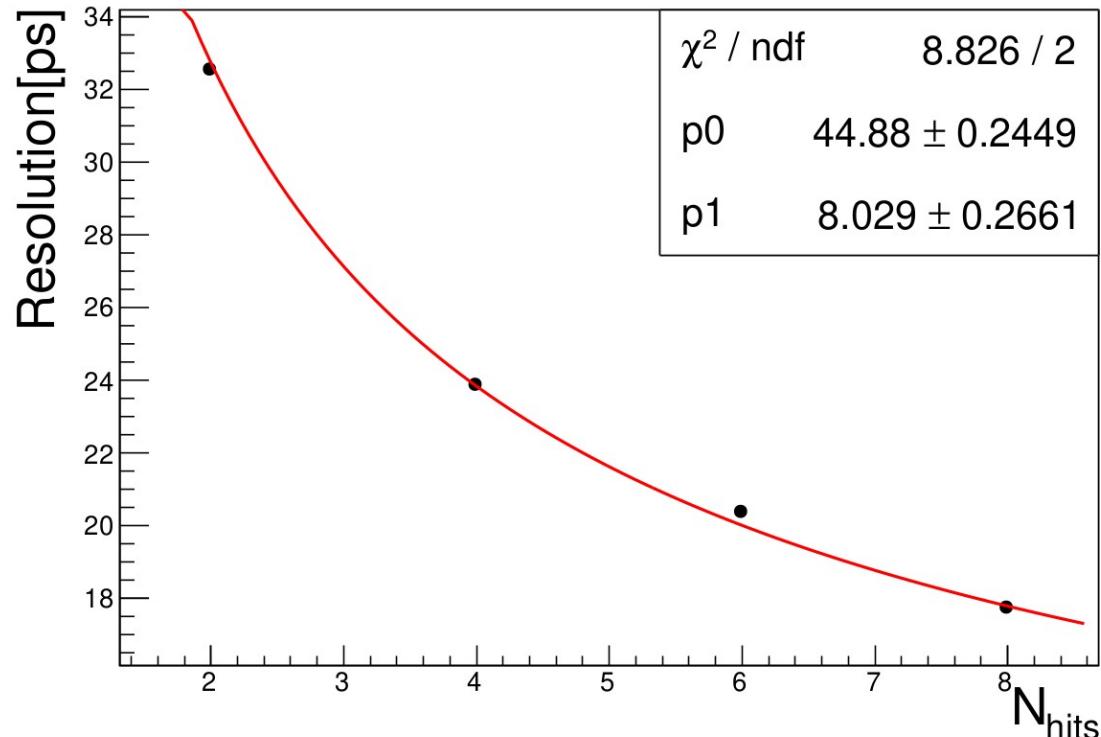


# The Mu3e experiment (Phase 1)



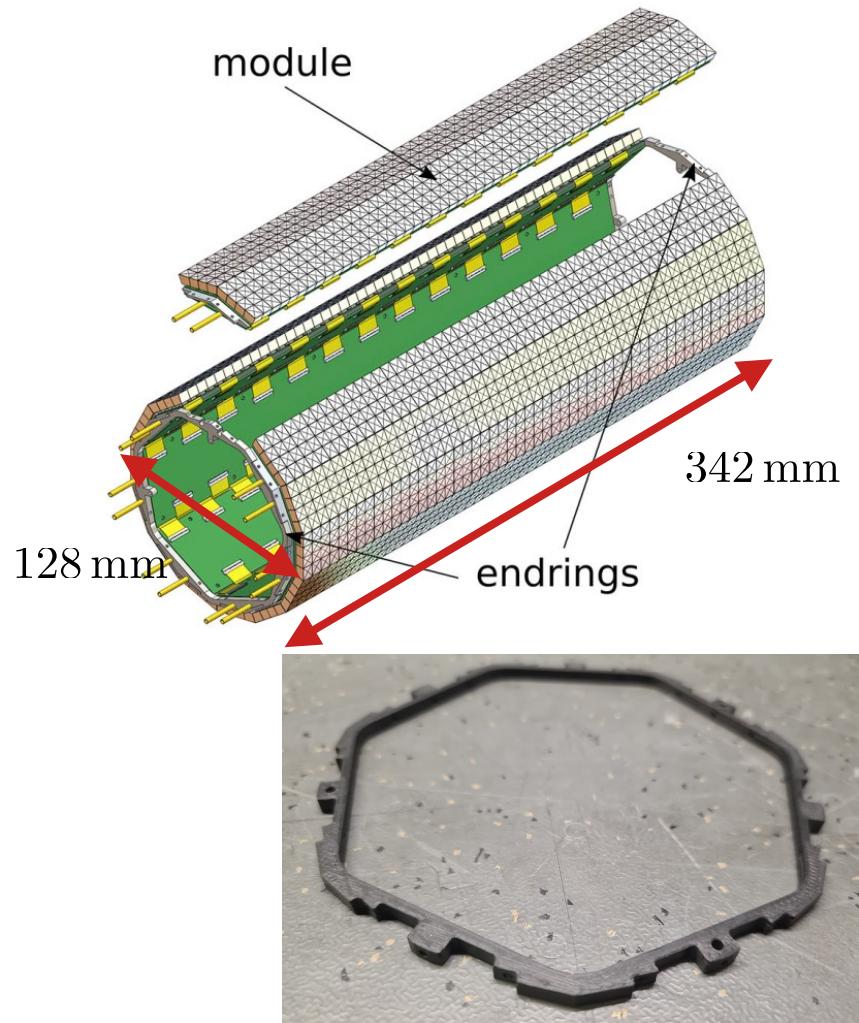
- $\sim 10^8$  muon/s on the target
- Vertex resolution  $\sim 0.5 \text{ mm}$
- Momentum resolution  $< 1 \text{ MeV}$
- Timing resolution  $< 500 \text{ ps}$  (Fibre) and  $< 100 \text{ ps}$  (Tile)

# The Mu3e Tile detector



- Single channel timing resolution  $\sim 45$  ps
- Resolution  $\sim 20$  ps for high-multiplicity events

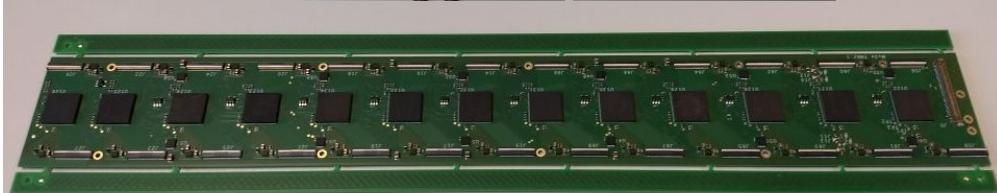
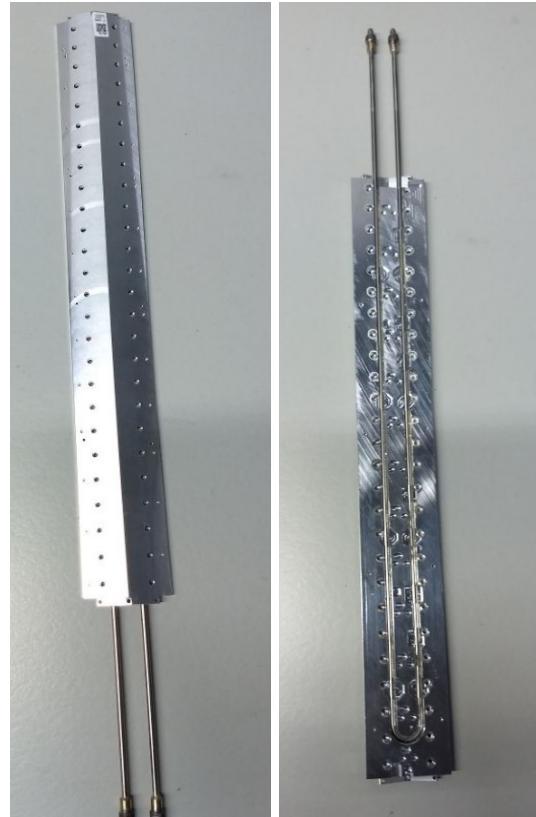
- **Recurl station (2)**
  - 7 modules per station
  - mounted on beampipe
  - 3D-printed PEEK endrings
- **Tile module (14)**
  - 26 tile matrices per module
  - readout electronics board (TMB)
    - 13 ASICs (MuTRiG)
  - support structure & liquid cooling
- **Tile matrix (364, 182 for 1st station)**
  - $\sim 25 \times 25 \text{ mm}^2$
  - 16 channels (tiles+SiPMs)
  - SiPMs:  $3 \times 3 \text{ mm}^2$
  - Tiles:  $6 \times 6 \times 5 \text{ mm}^2$  (plastic scintillator)



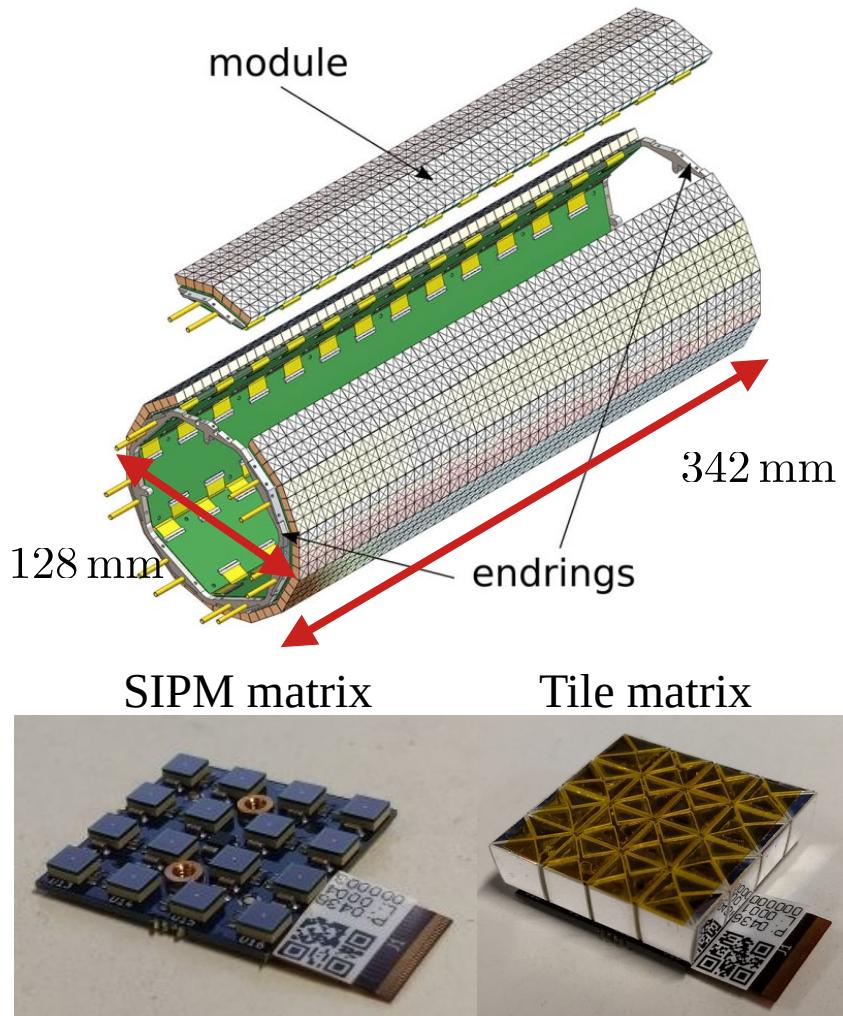
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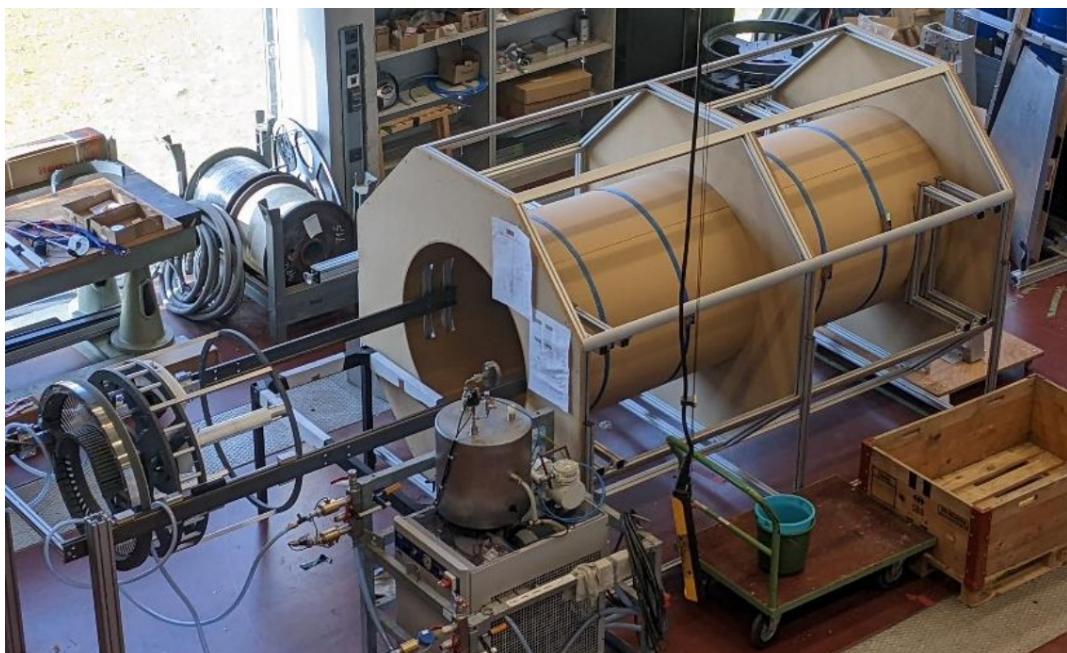
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  - 7 modules per station
  - mounted on beampipe
  - 3D-printed PEEK endrings
- **Tile module (14)**
  - 26 tile matrices per module
  - readout electronics board (TMB) – **14%**
  - 13 ASICs (MuTRiG)
  - support structure & liquid cooling – **100%**
- **Tile matrix (364, 182 for 1st station)**
  - ~ 25 x 25 mm<sup>2</sup> – **56% (~25% tested)**
  - 16 channels (tiles+SiPMs)
  - SiPMs: 3x3 mm<sup>2</sup> – **56%**
  - Tiles: 6x6x5 mm<sup>2</sup> (plastic scintillator)



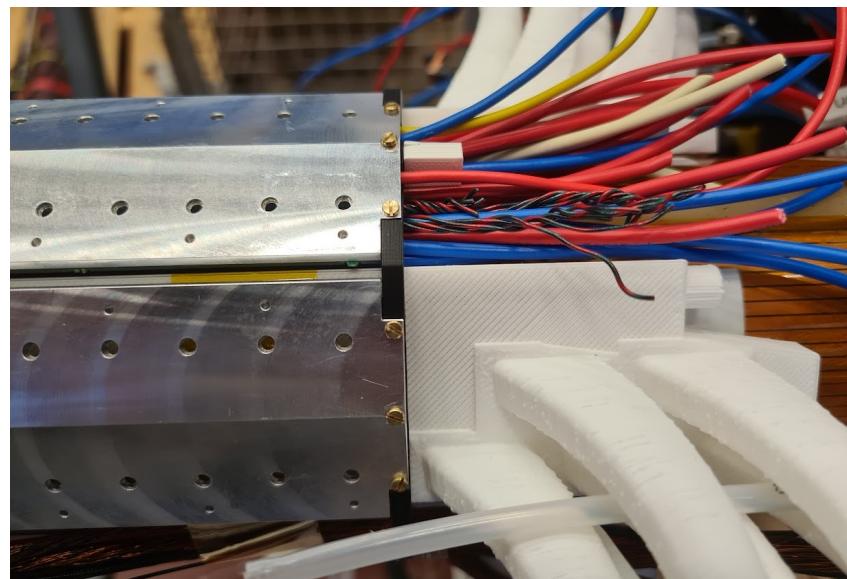
- Integration of one station into the experiment — mid 2024
- Limited space for installation of detector cables and pipes
  - Restricted due to beam pipe and other services
- Full-size mock-up in Heidelberg for testing
  - Cabling and mechanics
  - Cooling
  - Tile detector integration
- QA of the produced components of the detector
  - SiPM matrices
  - Tile matrices
  - MuTRiGs
  - Tile modules



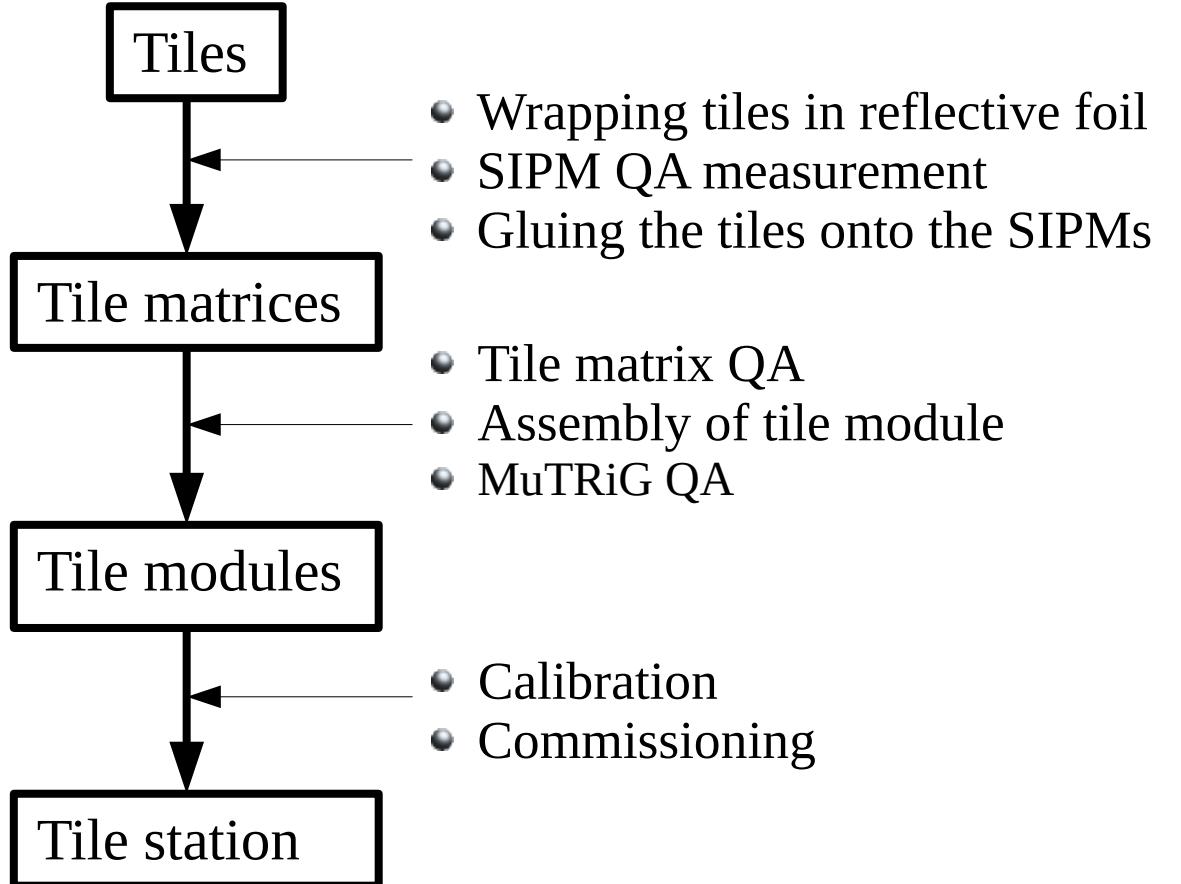
# Detector integration



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- Limited space for installation of detector cables and pipes
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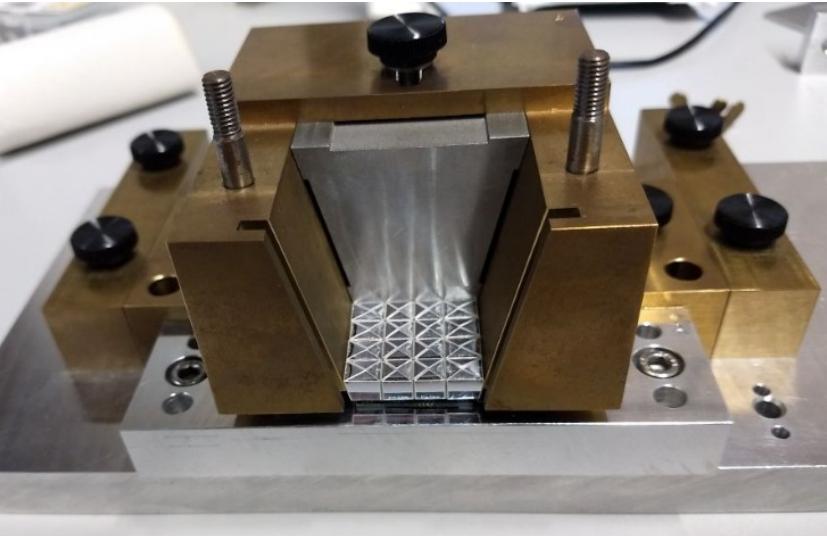
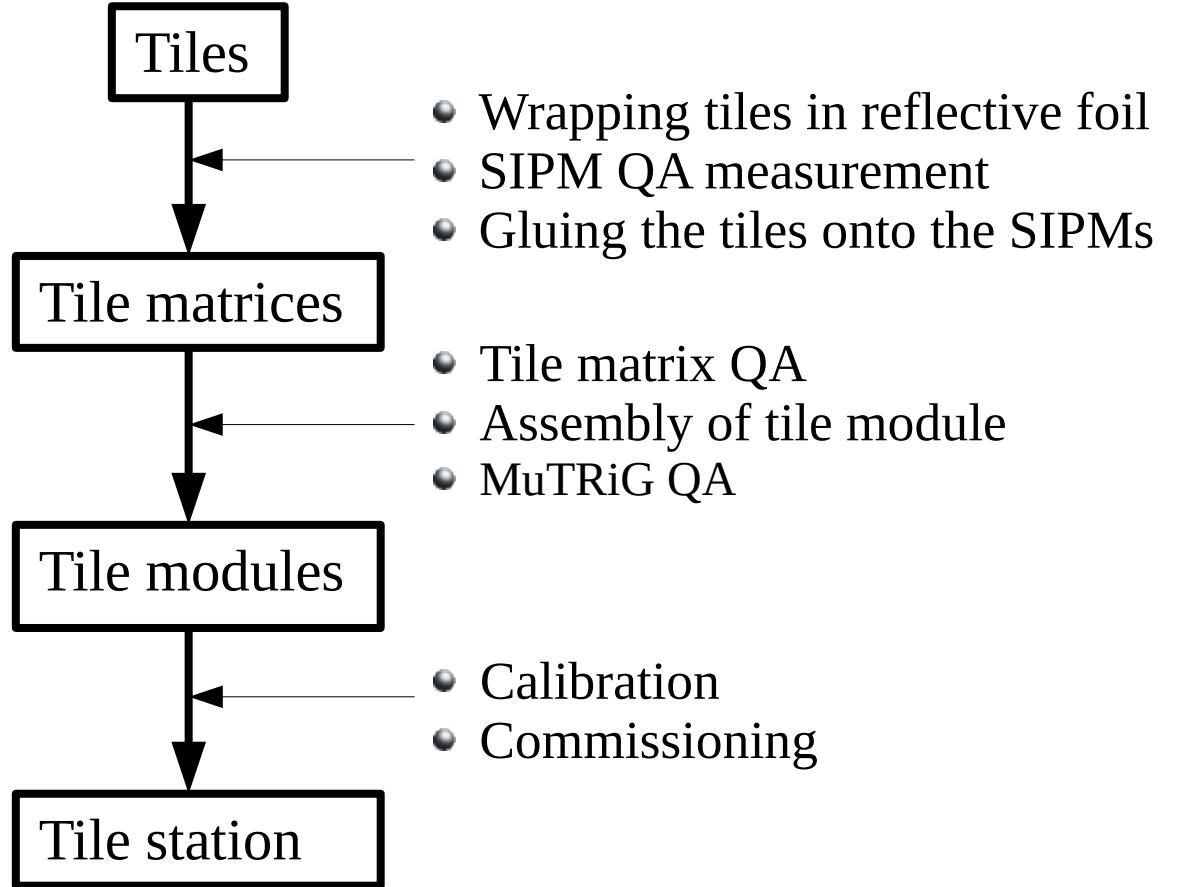


# Production: tile matrix

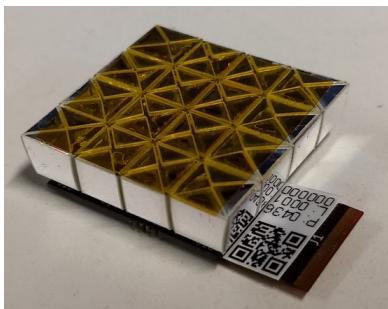


Wrapping station

# Production: tile matrix

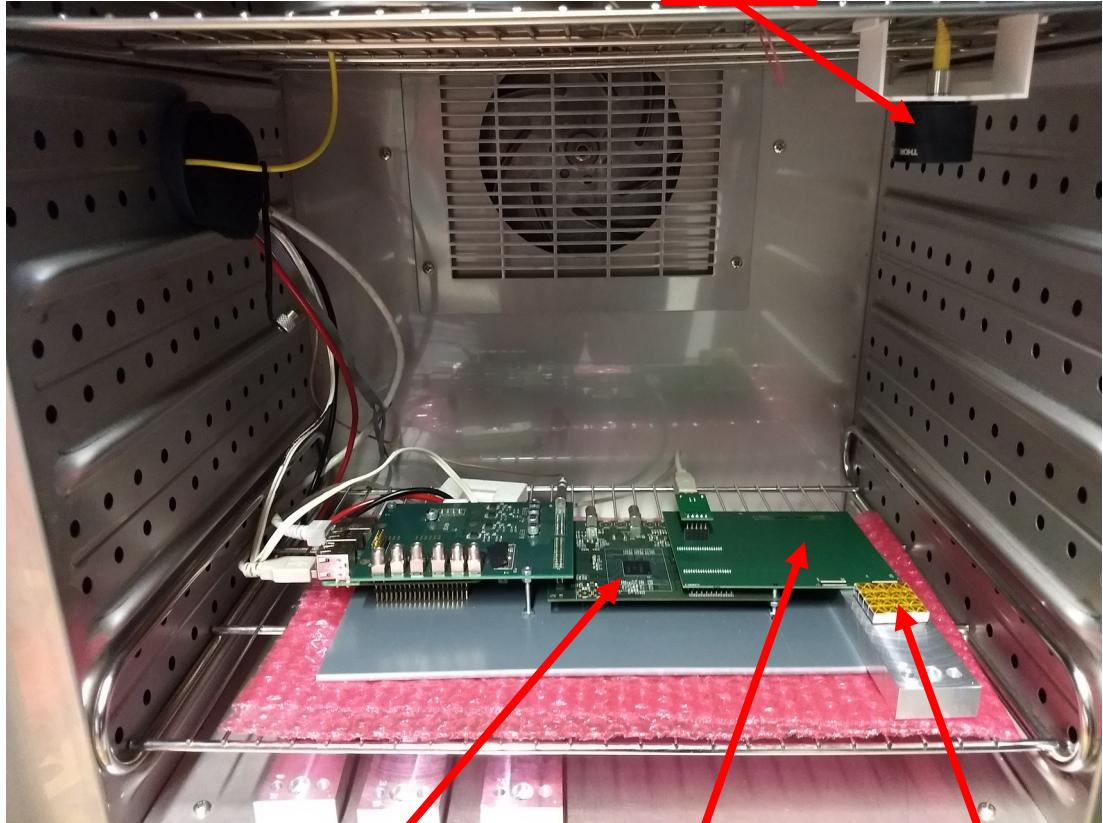
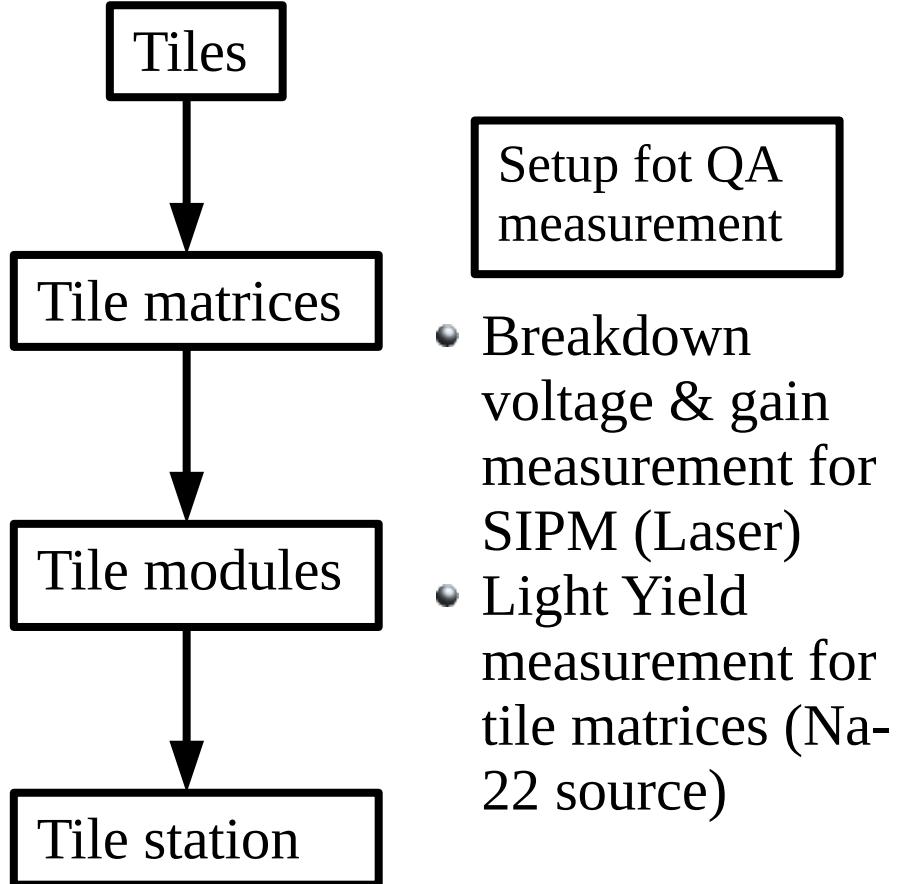


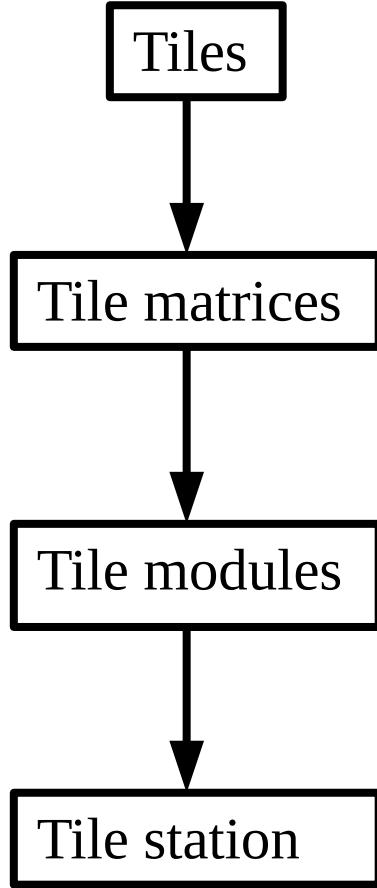
Gluing station



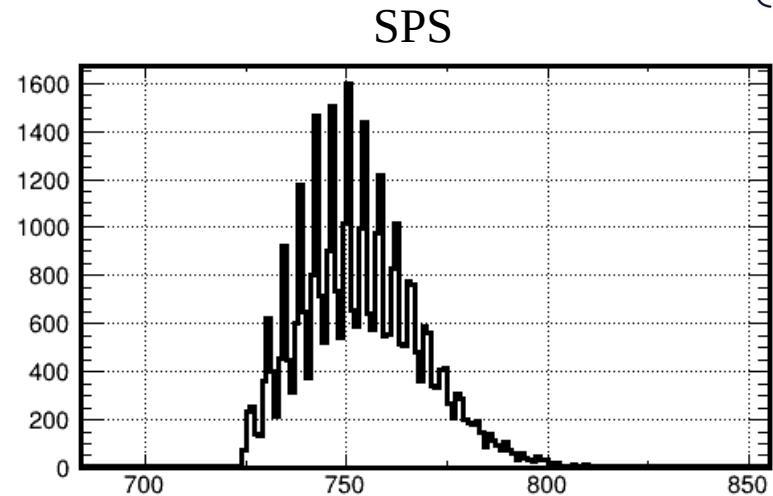
Tile matrix

# Matrix characterization & QA

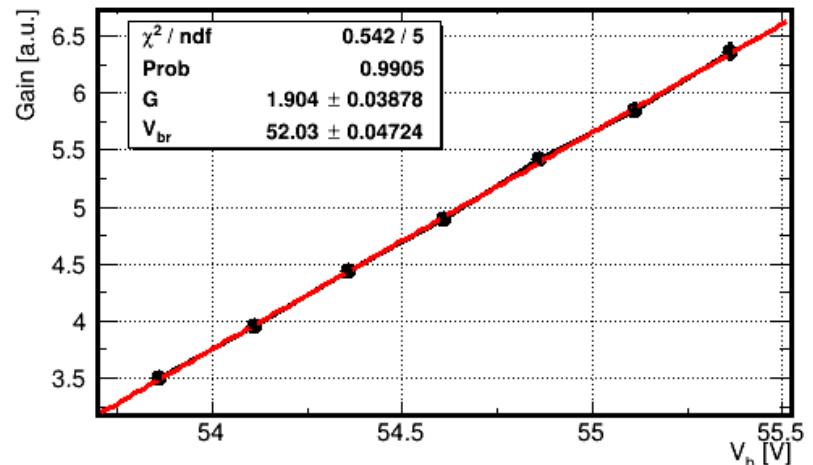




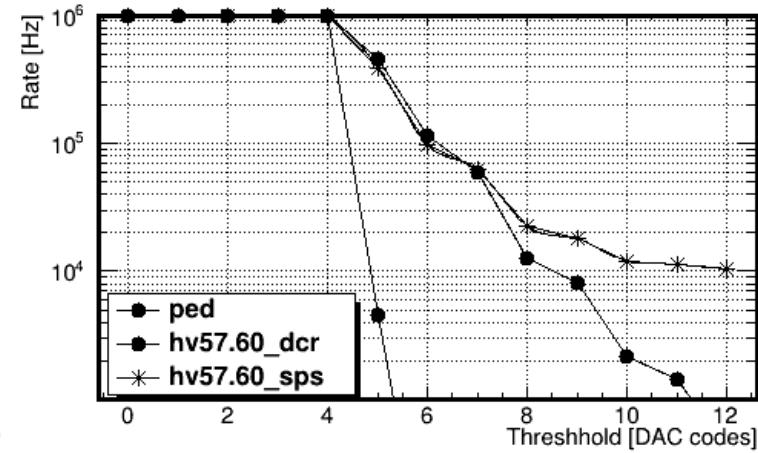
QA measurement:  
SiPM matrix



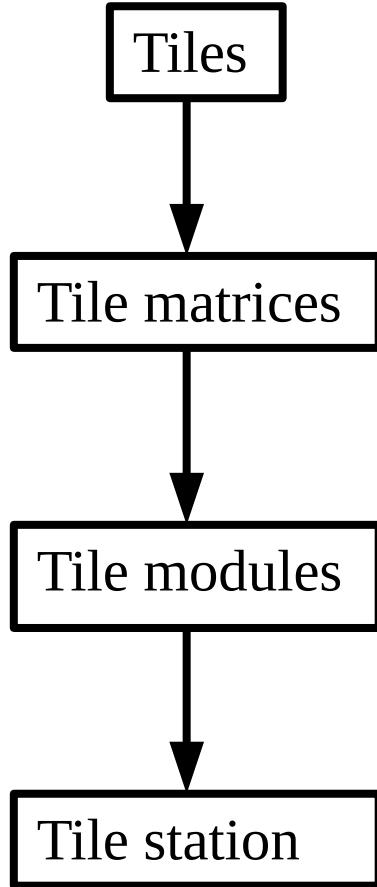
Gain fit



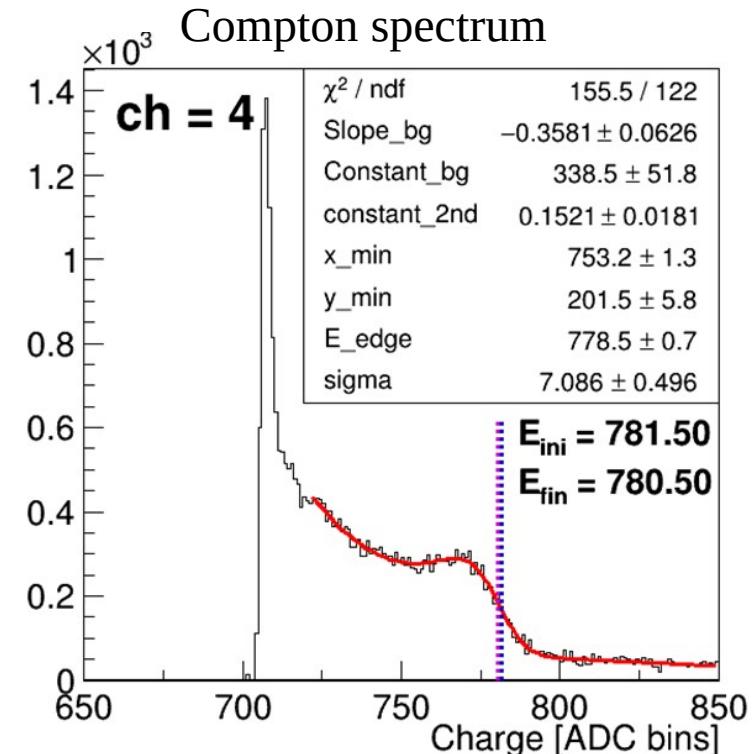
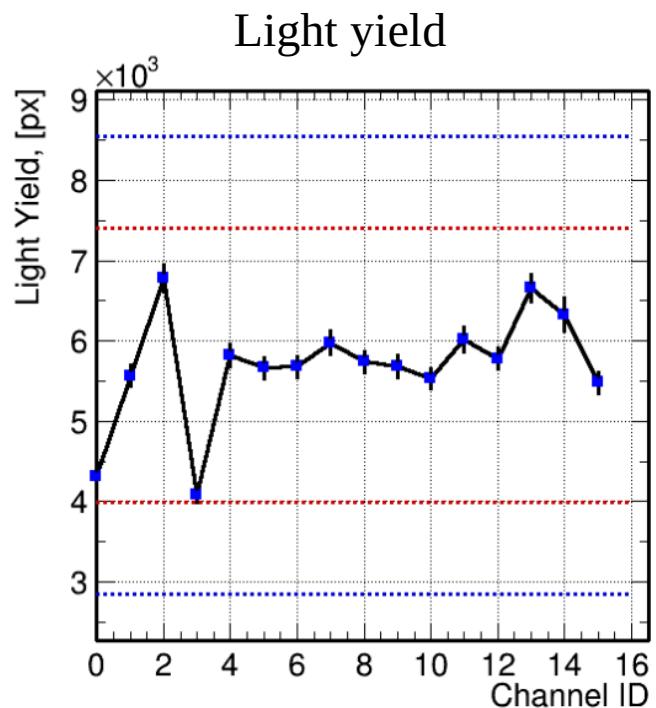
Noise rates



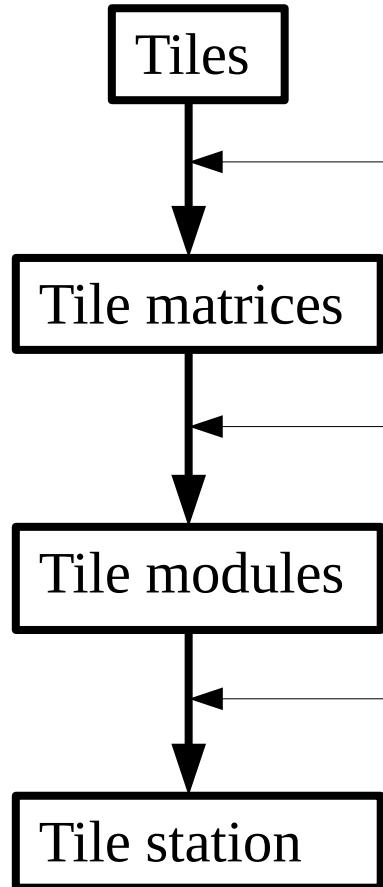
# Matrix characterization & QA



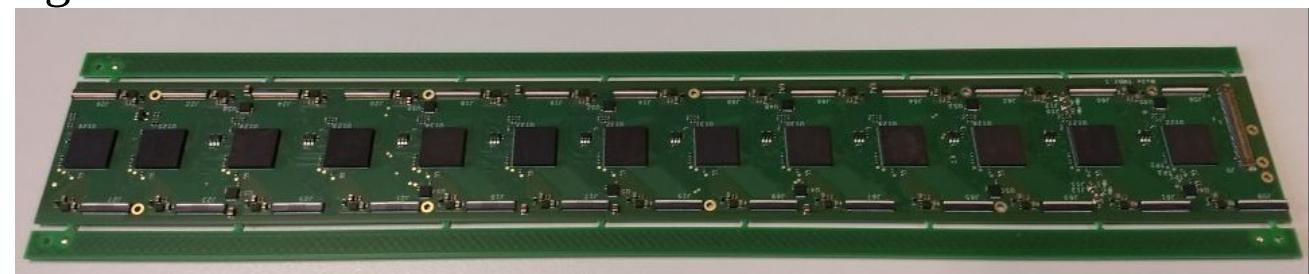
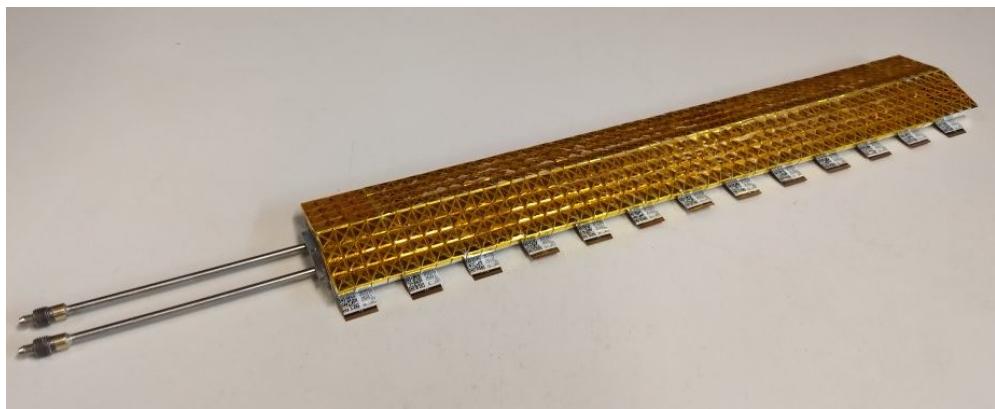
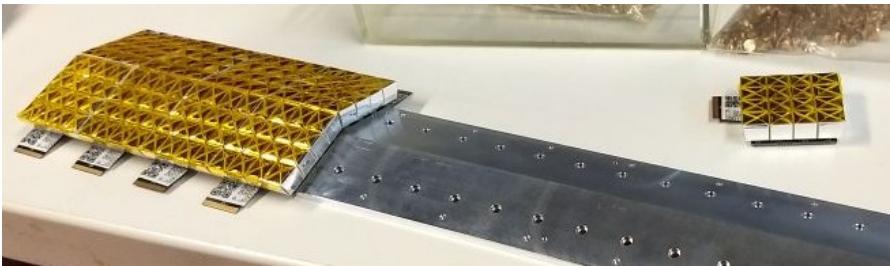
QA measurement:  
Tile matrix



# Production: tile module



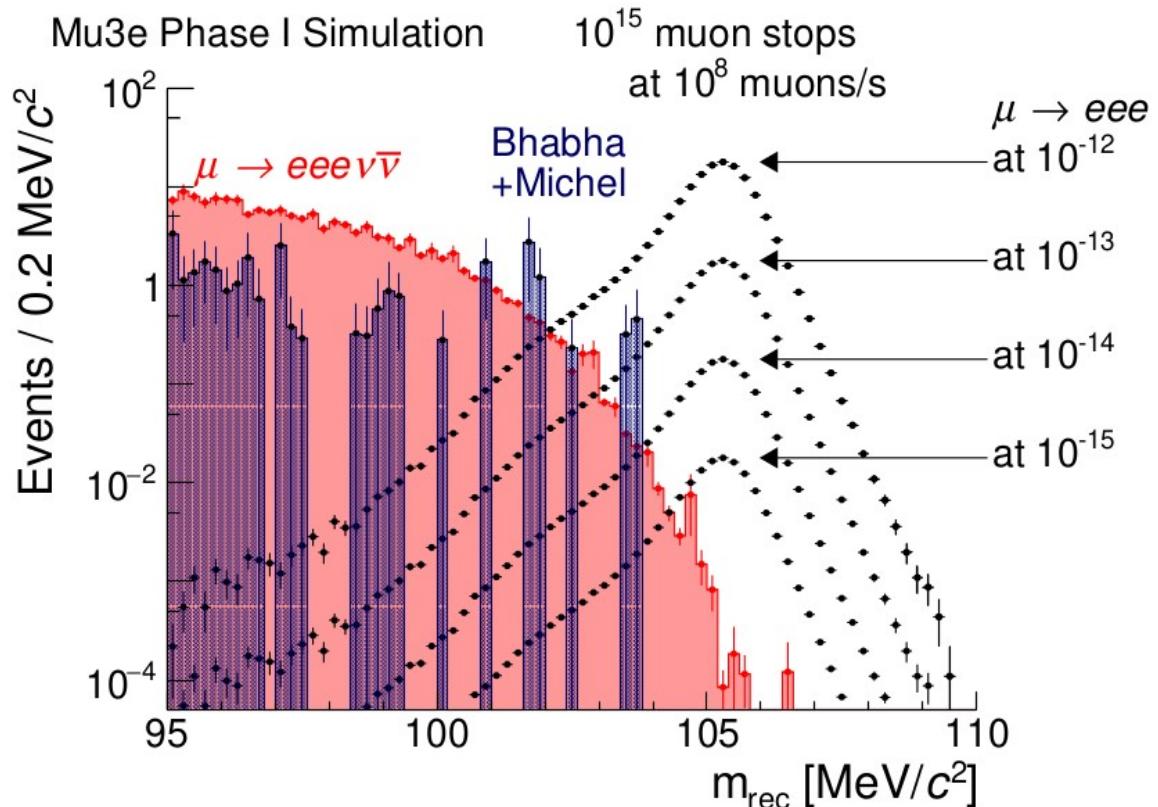
- Wrapping tiles in reflective foil
  - SIPM QA measurement
  - Gluing the tiles onto the SIPMs
- 
- Tile matrix QA
  - Assembly of tile module
  - MuTRiG QA
- 
- Calibration
  - Commissioning



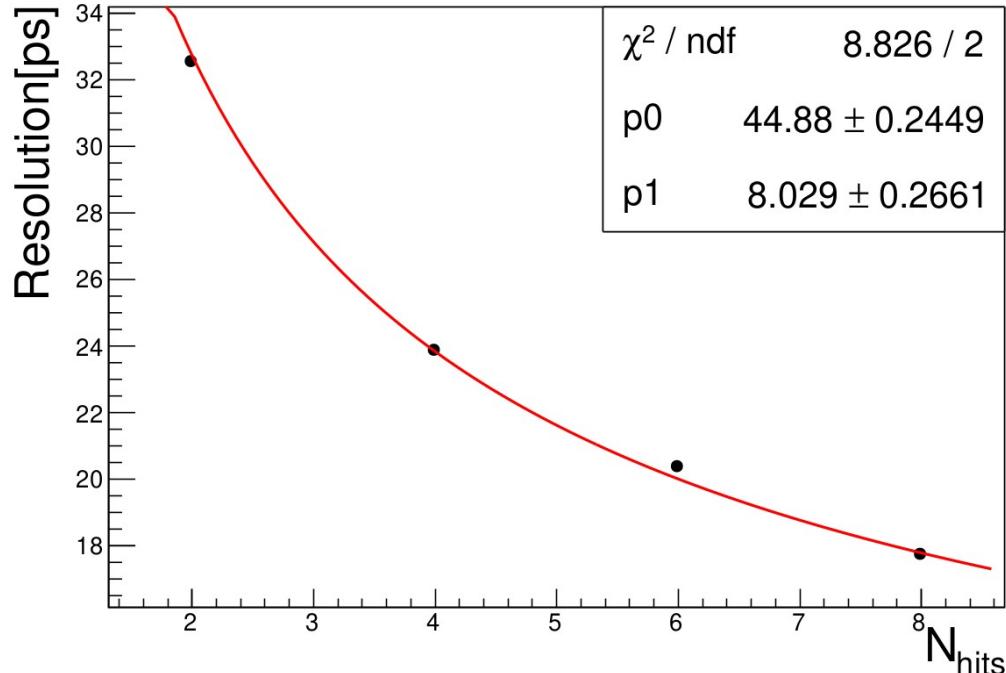
- Designs of all detector components are finalized
- Production of detector components is on-going
- Characterization and QA of the components is under way
- Outlook:
  - Assembly of the tile modules
  - Calibration of the modules
  - Commissioning
  - Integration of one station into the experiment - mid 2024



Thank you for your attention!

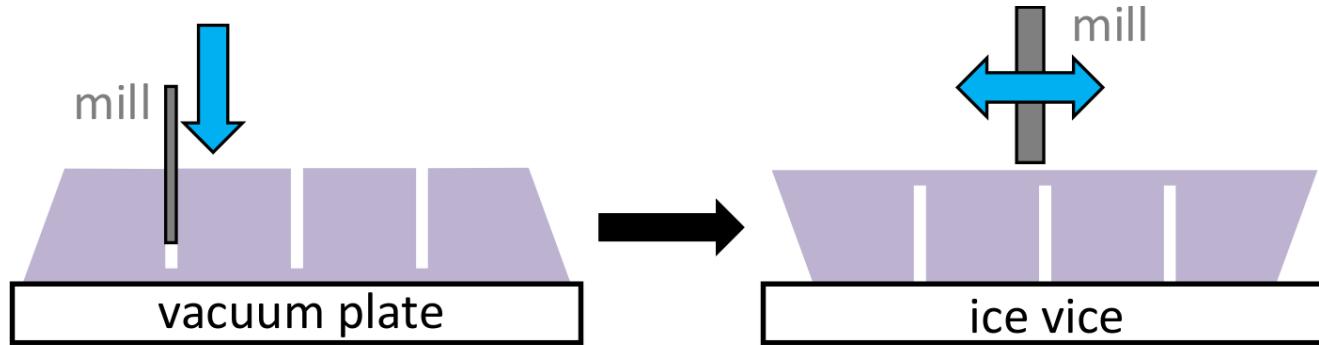


- invariant mass for signal events at various branching fractions and events from radiative decays with internal conversion
- accidental background from combinations of Bhabha pairs and Michel electrons
- The center-of-mass momentum is required to be  $< 4$  MeV/c



$$\sigma_t(N_{\text{hits}}) = \sigma_t^{\text{single}} / \sqrt{N_{\text{hit}}} \oplus \sigma_t^{\text{const}}$$

- Single channel timing resolution  $\sim 45$  ps
- Resolution  $\sim 20$  ps for high-multiplicity events
- Even-odd analysis: hits are grouped based on channel position and time difference



- Large-scale tile production using ice-vice system
- Small tiles are difficult to mill/polish
- Freeze-clamp to a plate during machining ( $-10^{\circ}\text{C}$ )
- Cut out full matrices from scintillator plate
- production time per matrix < 30 minutes

